DIGITRON SEMICONDUCTORS

MCR218 SERIES

SILICON CONTROLLED RECTIFIERS

Available Non-RoHS (standard) or RoHS compliant (add PBF suffix). Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak repetitive off-state voltage ⁽¹⁾			
$(T_1 = -40 \text{ to } +125^{\circ}\text{C}, \text{ gate open})$			
MCR218-2		50	
MCR218-3	V _{drm} V _{rrm}	100	
MCR218-4		200	V
MCR218-6		400	
MCR218-7		500	
MCR218-8		600	
MCR218-10		800	
On-state RMS current (180° conduction angles, $T_C = 70$ °C)	$I_{T(RMS)}$	8.0	А
Peak non-repetitive surge current	T		А
(one half-cycle, sine wave, 60Hz, $T_{J} = 125^{\circ}C$)	I _{TSM}	100	A
Circuit fusing consideration (t = 8.3ms)	I ² t	26	A ² s
Forward peak gate power (pulse width $\leq 1.0\mu$ s, T _C = 70°C)	P _{GM}	5	W
Forward average gate power (t = 8.3 ms, T _c = 70 °C)	P _{G(AV)}	0.5	W
Forward peak gate current (pulse width \leq 1.0µs, T _c = 70°C)	I _{GM}	2.0	А
Operating temperature range	TJ	-40 to +125	°C
Storage temperature range	T _{stg}	-40 to +150	°C

Note 1: V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Maximum	Unit
Thermal resistance, junction to case	R _{⊖JC}	2.0	°C/W
Maximum lead temperature for soldering purposes 1/8" from case for 10s	TL	260	°C

ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise noted)

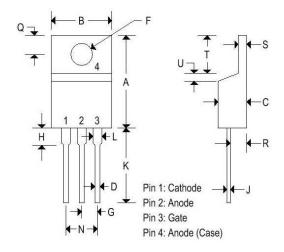
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•	•	•	•	•
Peak forward or reverse blocking current (V_{AK} = Rated V_{DRM} or V_{RRM} , gate open)	I _{DRM,}				
$T_{J} = 25^{\circ}C$ $T_{J} = 125^{\circ}C$	I _{RRM}	-	-	10 2.0	μA mA
ON CHARACTERISTICS					
Peak on-state voltage [*] (I _{TM} = 16A peak)	V _{TM}	_	1.5	1.8	V
Gate trigger current (continuous dc) ($V_D = 12V$, $R_L = 100\Omega$)	I _{GT}	-	10	25	mA
Gate trigger voltage (continuous dc) ($V_D = 12V$, $R_L = 100\Omega$)	V _{GT}	-	-	1.5	v
Gate non-trigger voltage (Rated 12V, $R_L = 100\Omega$, $T_J = 125^{\circ}C$)	V _{GD}	0.2	-	_	v
Holding current ($V_D = 12V$, initiating current = 200mA, gate open)	I _H	-	16	30	mA
DYNAMIC CHARACTERISTICS					
Critical rate of rise of off-state voltage (V_D = rated V_{DRM} , exponential waveform, gate open, T_J = 125°C)	dv/dt	-	100	-	V/µs
* Pulse width ≤ 1.0 ms, duty cycle $\leq 2\%$.					

* Pulse width \leq 1.0ms, duty cycle \leq 2%.

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MECHANICAL CHARACTERISTICS

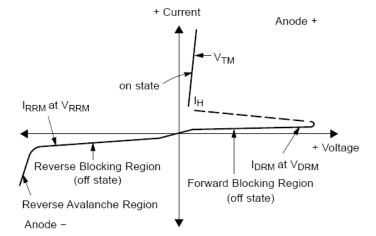
Case	TO-220AB
Marking	Alpha-numeric
Pin out	See below



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	TO-220AB			
	Inc	Inches		neters
	Min	Max	Min	Max
Α	0.575	0.620	14.600	15.750
В	0.380	0.405	9.650	10.290
С	0.160	0.190	4.060	4.820
D	0.025	0.035	0.640	0.890
F	0.142	0.147	3.610	3.730
G	0.095	0.105	2.410	2.670
Н	0.110	0.155	2.790	3.930
J	0.014	0.022	0.360	0.560
K	0.500	0.562	12.700	14.270
L	0.045	0.055	1.140	1.390
Ν	0.190	0.210	4.830	5.330
Q	0.100	0.120	2.540	3.040
R	0.080	0.110	2.040	2.790
S	0.045	0.055	1.140	1.390
Т	0.235	0.255	5.970	6.480
U		0.050	-	1.270
٧	0.045	320	1.140	1953
Z		0.080	-	2.030

Voltage Current Characteristic of SCR

Symbol	Parameter
VDRM	Peak Repetitive Off State Forward Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Off State Reverse Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Peak On State Voltage
Ι _Η	Holding Current



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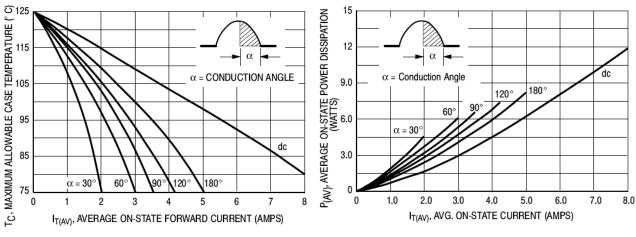
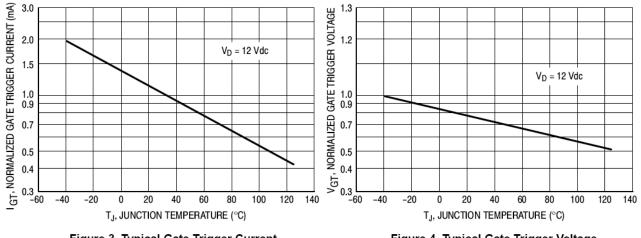


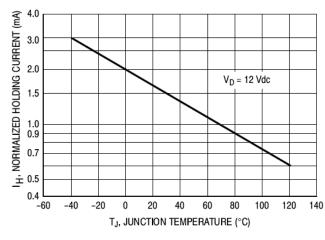


Figure 2. On-State Power Dissipation











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